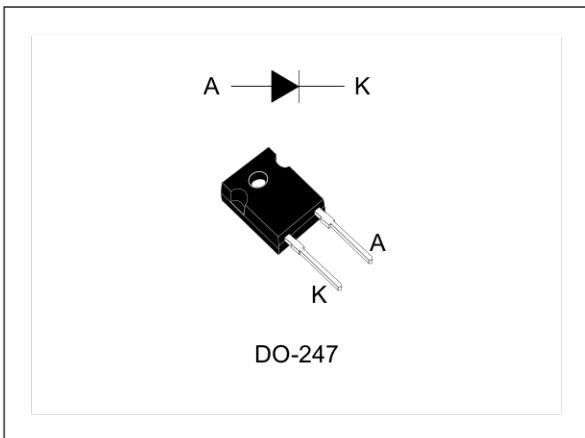


## Automotive ultrafast recovery - high voltage diode

Datasheet - production data



### Features

- AEC-Q101 qualified
- Ultrafast, soft recovery
- Very low conduction and switching losses
- High frequency and/or high pulsed current operation
- High reverse voltage capability
- High junction temperature
- ECOPACK®2 compliant component

### Description

The high quality design of this diode has produced a device with low leakage current, regularly reproducible characteristics and intrinsic ruggedness. These characteristics make it ideal for heavy duty applications that demand long term reliability like automotive applications.

These diodes also fit into auxiliary functions such as snubber, bootstrap, and demagnetization applications.

The improved performance in low leakage current, and therefore thermal runaway guard band, is an immediate competitive advantage for this device.

**Table 1. Device summary**

$I_{F(AV)}$	60 A
$V_{RRM}$	1000 V
$T_j$ (max.)	175 °C
$V_F$ (typ)	1.3 V
$t_{rr}$ (typ)	49 ns

# 1 Characteristics

**Table 2. Absolute ratings (limiting values at 25 °C, unless otherwise specified)**

Symbol	Parameter	Value	Unit
V <sub>RRM</sub>	Repetitive peak reverse voltage	1000	V
I <sub>F(RMS)</sub>	Forward rms current	80	A
I <sub>F(AV)</sub>	Average forward current	T <sub>C</sub> = 75 °C, δ = 0.5, square wave	60
I <sub>FRM</sub>	Repetitive peak forward current	t <sub>p</sub> = 5 μs, F = 5 kHz square	450
I <sub>FSM</sub>	Surge non repetitive forward current	t <sub>p</sub> = 10 ms sinusoidal	400
T <sub>stg</sub>	Storage temperature range	-65 to + 175	°C
T <sub>j</sub>	Operating junction temperature range	-40 to + 175	°C

**Table 3. Thermal parameters**

Symbol	Parameter	Value	Unit
R <sub>th(j-c)</sub>	Junction to case	0.78	°C/W

**Table 4. Static electrical characteristics**

Symbol	Parameter	Test conditions		Min.	Typ.	Max.	Unit
I <sub>R</sub> <sup>(1)</sup>	Reverse leakage current	T <sub>j</sub> = 25 °C	V <sub>R</sub> = V <sub>RRM</sub>	-		20	μA
		T <sub>j</sub> = 125 °C		-	20	200	
V <sub>F</sub> <sup>(2)</sup>	Forward voltage drop	T <sub>j</sub> = 25 °C	I <sub>F</sub> = 60 A	-		2.0	V
		T <sub>j</sub> = 100 °C		-	1.4	1.8	
		T <sub>j</sub> = 150 °C		-	1.3	1.7	

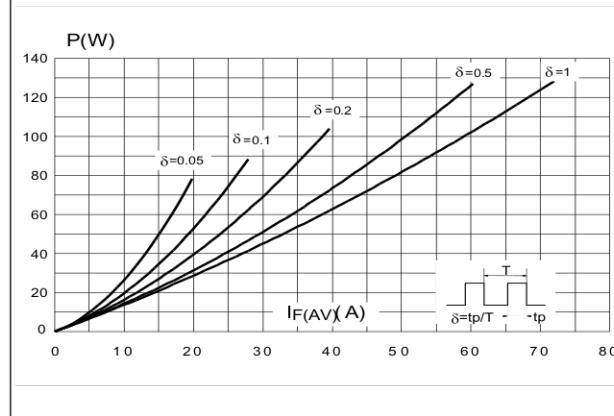
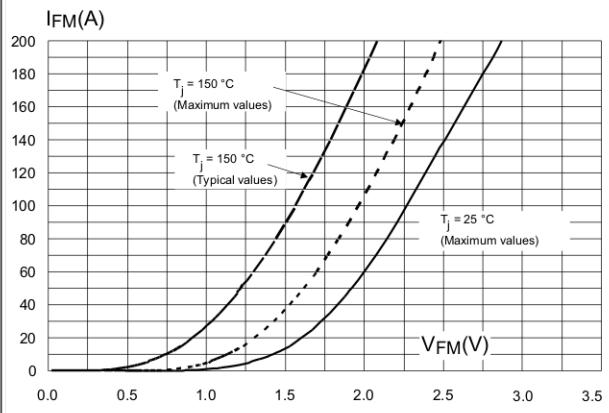
1. Pulse test: t<sub>p</sub> = 5 ms, δ < 2%2. Pulse test: t<sub>p</sub> = 380 μs, δ < 2%

To evaluate the conduction losses use the following equation:

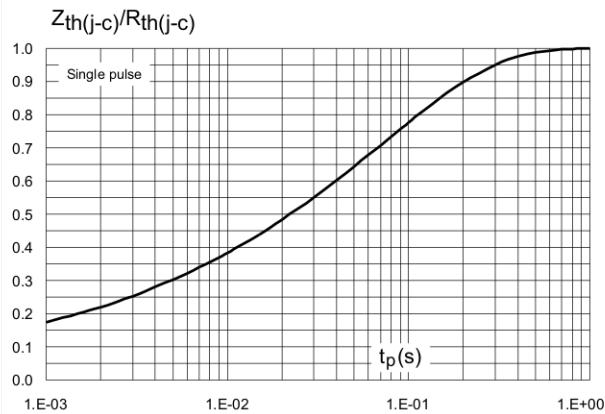
$$P = 1.3 \times I_{F(AV)} + 0.0067 I_{F(RMS)}^2$$

**Table 5. Dynamic characteristics**

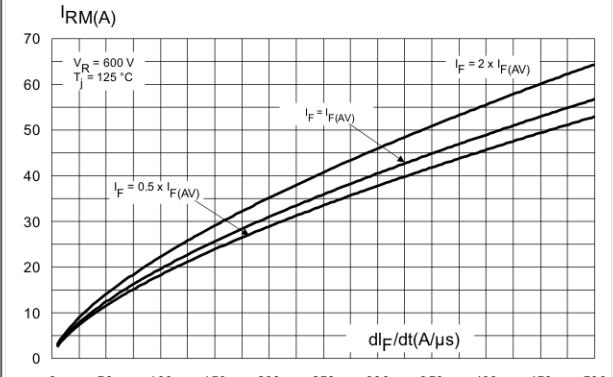
Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{rr}$	Reverse recovery time	$I_F = 1 \text{ A}, dI_F/dt = -50 \text{ A}/\mu\text{s}, V_R = 30 \text{ V}, T_j = 25^\circ\text{C}$	-		115	ns
		$I_F = 1 \text{ A}, dI_F/dt = -100 \text{ A}/\mu\text{s}, V_R = 30 \text{ V}, T_j = 25^\circ\text{C}$	-	61	80	
		$I_F = 1 \text{ A}, dI_F/dt = -200 \text{ A}/\mu\text{s}, V_R = 30 \text{ V}, T_j = 25^\circ\text{C}$	-	49	65	
$I_{RM}$	Reverse recovery current	$I_F = 60 \text{ A}, dI_F/dt = -200 \text{ A}/\mu\text{s}, V_R = 600 \text{ V}, T_j = 125^\circ\text{C}$	-	31	40	A
S	Softness factor	$I_F = 60 \text{ A}, dI_F/dt = -200 \text{ A}/\mu\text{s}, V_R = 600 \text{ V}, T_j = 125^\circ\text{C}$	-	1		
$t_{fr}$	Forward recovery time	$I_F = 60 \text{ A}, dI_F/dt = 100 \text{ A}/\mu\text{s}, V_{FR} = 1.5 \times V_{Fmax}, T_j = 25^\circ\text{C}$	-		750	ns
$V_{FP}$	Forward recovery voltage	$I_F = 60 \text{ A}, dI_F/dt = 100 \text{ A}/\mu\text{s}, T_j = 25^\circ\text{C}$	-	4		V

**Figure 1. Conduction losses versus average current****Figure 2. Forward voltage drop versus forward current**

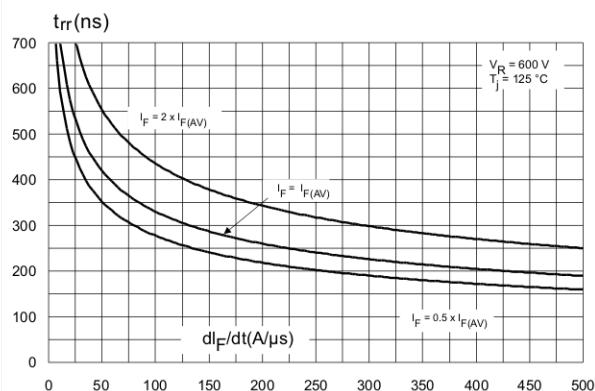
**Figure 3. Relative variation of thermal impedance junction to case versus pulse duration**



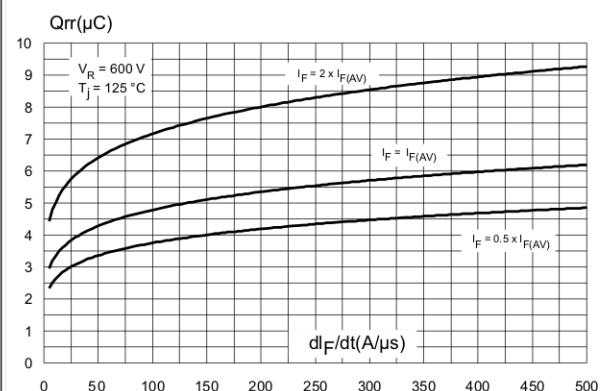
**Figure 4. Peak reverse recovery current versus  $dI_F/dt$  (typical values)**



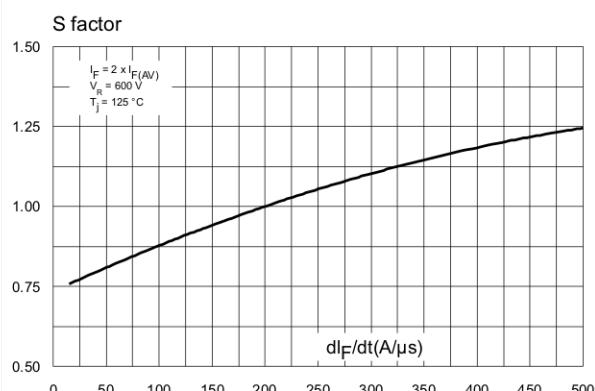
**Figure 5. Reverse recovery time versus  $dI_F/dt$  (typical values)**



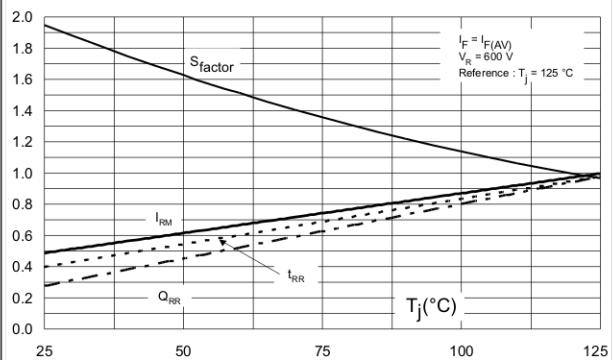
**Figure 6. Reverse recovery charges versus  $dI_F/dt$  (typical values)**

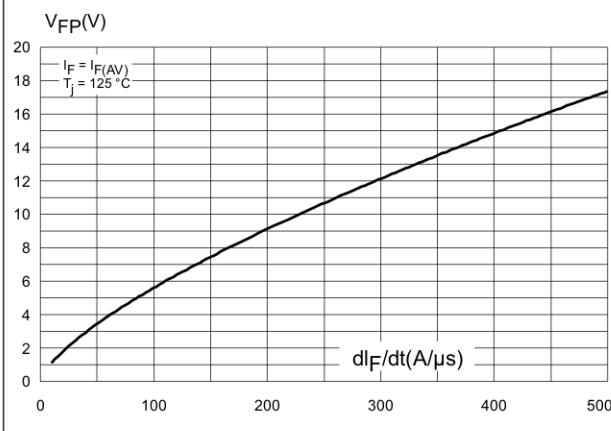
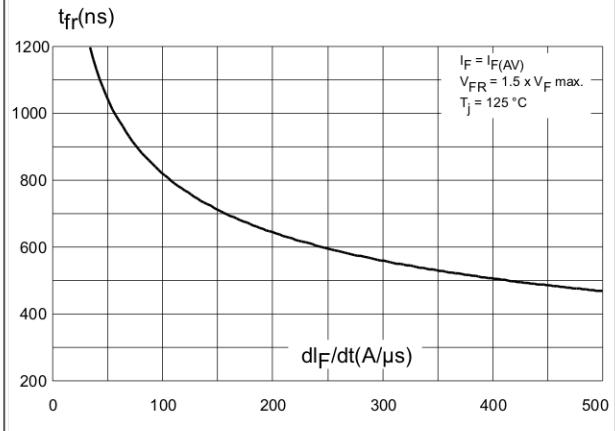
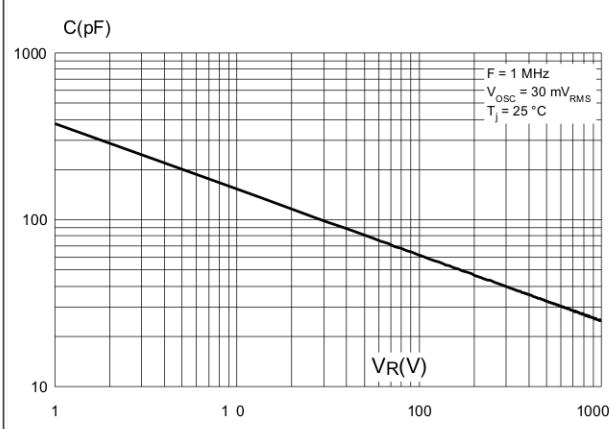
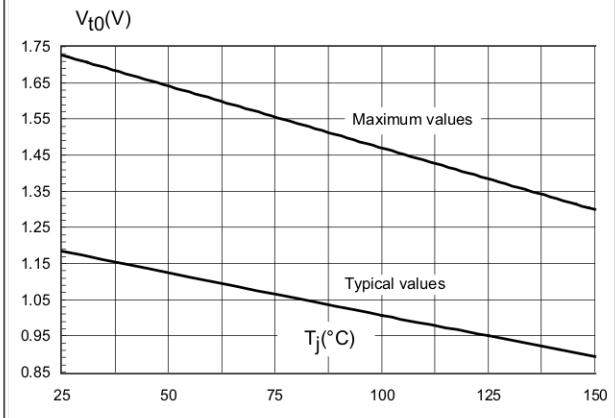
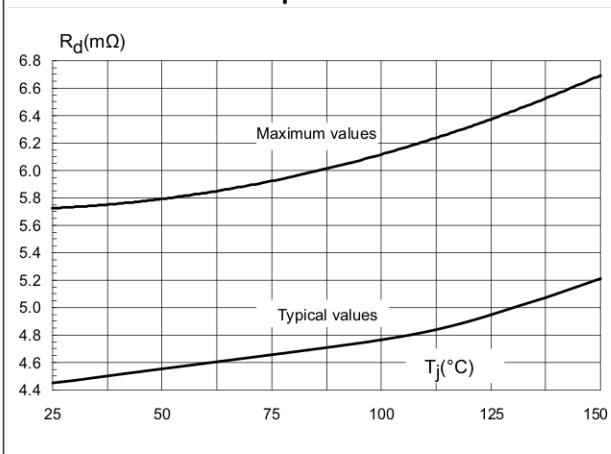


**Figure 7. Softness factor versus  $dI_F/dt$  (typical values)**



**Figure 8. Relative variations of dynamic parameters versus junction temperature**



**Figure 9. Transient peak forward voltage versus  $dI_F/dt$  (typical values)****Figure 10. Forward recovery times versus  $dI_F/dt$  (typical values)****Figure 11. Junction capacitance versus reverse voltage applied (typical values)****Figure 12. Threshold voltage versus junction temperature****Figure 13. Dynamic resistance versus junction temperature**

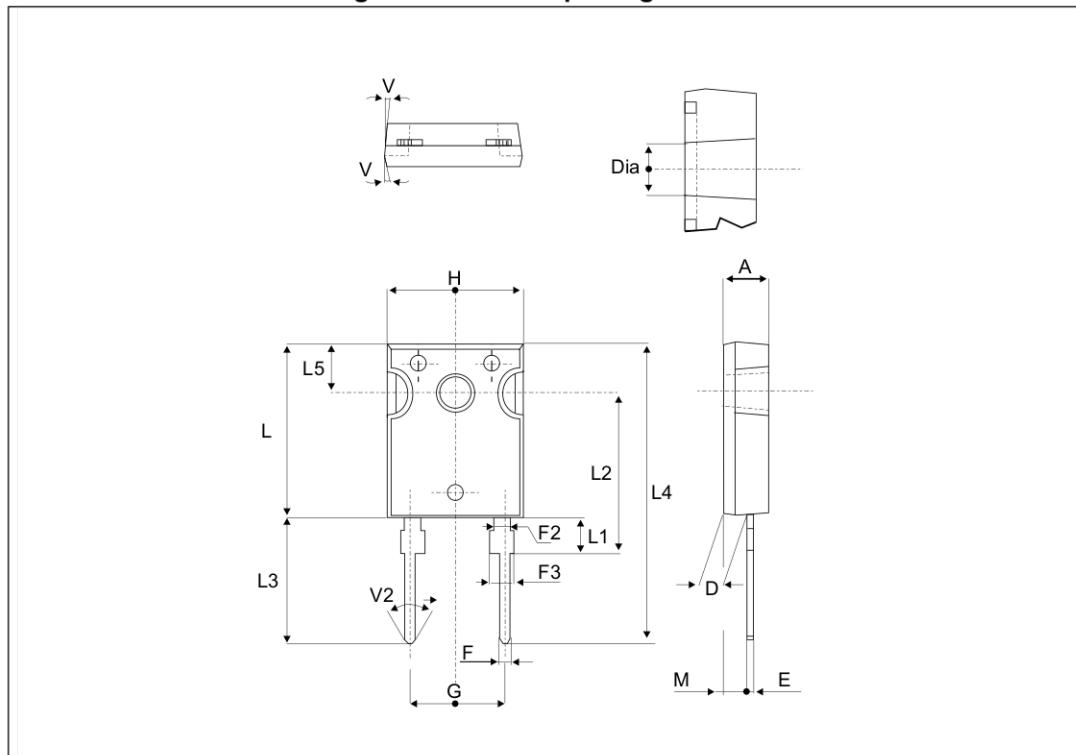
## 2 Package information

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)
- Recommended torque value: 0.80 N·m
- Maximum torque value: 1.0 N·m

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com).  
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### 2.1 DO-247 package information

Figure 14. DO-247 package outline



**Table 6. DO-247 package mechanical data**

Ref.	Dimensions					
	Millimeters			Inches <sup>(1)</sup>		
	Typ.	Min.	Max.	Typ.	Min.	Max.
A		4.85	5.15		0.191	0.203
D		2.20	2.60		0.086	0.102
E		0.40	0.80		0.015	0.031
F		1.00	1.40		0.039	0.055
F2	2.00			0.078		
F3		2.00	2.40		0.078	0.094
G	10.90			0.429		
H		15.45	15.75		0.608	0.620
L		19.85	20.15		0.781	0.793
L1		3.70	4.30		0.145	0.169
L2	18.50			0.728		
L3		14.20	14.80		0.559	0.582
L4	34.60			1.362		
L5	5.50			0.216		
M		2.00	3.00		0.078	0.118
V	5°			5°		
V2	60°			60°		
Dia.		3.55	3.65		0.139	0.143

1. Values in inches are converted from mm and rounded to 4 decimal digits.

### 3 Ordering information

**Table 7. Ordering information**

Order code	Marking	Package	Weight	Base qty.	Delivery mode
STTH6010WY	STTH6010WY	DO-247	4.4 g	30	Tube

### 4 Revision history

**Table 8. Document revision history**

Date	Revision	Changes
04-Nov-2011	1	Initial release.
22-Apr-2015	2	Added <a href="#">Figure 12</a> and <a href="#">Figure 13</a> . Document updated to current standard.

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